

**CONTACT DATA** 

Accepts 0.20mm - 0.33mm Diameter pins

3-finger

37/25 gram, Initial insertion force (with 0.254mm/0.203mm dia. pin)

30/22 gram, normal force (with 0.254mm/0.203mm dia. pin)

20/17 gram, extraction force (with 0.254mm0.203mm dia. pin)

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Substrate: 1.59mm ±0.18mm [0.0625" ±0.007"] FR4/G10 or equivalent high temp material. (RoHS)



Pins: material- Brass Alloy 360 1/2 hard; finish-0.25μm [10μ"] Au over 1.27μm [50μ"] Ni (min.).



Contacts: Beryllium Copper Alloy172, HT; Finish-0.25μm [10μ"] Au over 1.27μm [50μ"] Ni (min.).



Solder Balls: see table above

Description: Giga-snaP BGA SMT Foot

372 position (1.27mm pitch) gold plated female receptacle pins to SMT solder balls (BGA type). Pin asignment 1:1.

<u>Tolerances:</u> diameters ±0.03mm [±0.001"], PCB perimeters ±0.18mm [±0.007"], PCB thicknesses ±0.18mm [±0.007"], pitches (from true position) ±0.08mm [±0.003"], all other tolerances ±0.13mm [±0.005"] unless stated otherwise. Materials and specifications are subject to change without notice.

SF-BGA372B-B-32(F) Drawing		Status: Released	Scale	4:1	Rev: A
© 2008	© 2008 IRONWOOD ELECTRONICS, INC. Tele: (952) 229-8200 www.ironwoodelectronics.com	Drawing: Vinayak R		Date:4/3/08	
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